Dopant homogeneity and transport properties of impurity-doped oxide nanowires

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Controlling and understanding an impurity doping on semiconductor oxide nanowires grown by the vapor-liquid-solid (VLS) method remains an important challenge. Homogeneous dopant distribution within oxide nanowires has been assumed without the direct evaluations to interpret the transport properties. Here we report the direct measurements of dopant distributions for Ta-doped SnO2 nanowires. We find that differences in dopant incorporations between VLS and vapor-solid growth processes give rise to a heavily doped shell surrounding an underdoped core. Thus, understanding the dopant incorporation pathways is essential to designing and controlling impurity doping on VLS grown oxide nanowires. © 2011 American Institute of Physics. [doi:10.1063/1.3549703]

Recent advanced semiconductor technology requires the precise control of an impurity doping on semiconductors to develop functional devices. Such controllability is also strongly required for vapor-liquid-solid (VLS) grown semiconductor nanowires toward functional nanowire device applications.1–15 Especially, the dopant distribution within nanowires has been a critical issue recently.6–9 For example, Perea et al. have performed the atom probe tomography to visualize the three-dimensional dopant distributions in Ge nanowires.9 Koren et al. investigated the active dopant distribution of phosphorus within Si nanowires by combining the field effect transistor and the sequential surface etching process.3 Previous reports consistently demonstrated the importance of the dopant distribution mostly for conventional semiconductor nanowires including Si, Ge, and compounds. Metal oxide nanowires are emerging potential candidates to add new functionalities such as transparent conductivity, ferroelectricity, and nonvolatile memory, which are hardly attainable in conventional semiconductors.6–11 Studies have been reported as to the effects of impurity doping on the electrical and magnetic properties of various VLS grown oxide nanowires.12,13 Especially VLS grown SnO2 nanowires with impurity doping have been intensively studied due to their transparent conductivity;13–15 for example, Ta-doped SnO2 nanowires.13 In these impurity-doped oxide nanowires, the uniform dopant distribution within oxide nanowires has been assumed without the direct evaluations to interpret the electrical properties.13–15 Here we report the direct measurements of dopant distributions for Ta-doped SnO2 nanowires. We find that differences in dopant incorporations between VLS and vapor-solid (VS) growth processes give rise to an inhomogeneity of dopant distribution, highlighting the importance of controlling the dopant incorporation pathways during VLS growth of oxide nanowires.

Ta-doped SnO2 nanowires were grown on Al2O3 (110) single crystal substrates by Au catalyst-assisted pulsed laser deposition technique (ArF excimer laser, λ = 193 nm).16 The background pressure of the chamber was 7.0 × 10−6 Pa. Sn metal and Ta2O5 mixed powders were milled and compressed to fabricate targets with varying Ta dopant concentrations. Ta dopant concentration (Ta at. %) is hereafter defined as Ta/(Ta + Sn). Oxygen and argon mixed gas was introduced into the chamber with the ambient total pressure of 10 Pa. The flux ratio of oxygen and argon was 1:1000.17 Prior to the laser ablation, the Au (0.7 nm)-coated Al2O3 substrate was preheated at the growth temperature of 750 °C for 20 min.18 After the nanowire growth, the samples were cooled down to room temperature (RT) within 30 min. The microstructure of the nanowires was characterized by field emission scanning electron microscopy (FESEM, Hitachi S-4300) at an accelerating voltage of 30 kV. High-resolution transmission electron microscopy (HRTEM, JEOL JEM-3000F) with energy dispersive spectroscopy (EDS) was used to evaluate the diameter, crystallinity, and macroscopic composition of nanowires. HRTEM measurement was performed at an accelerating voltage of 300 kV. Scanning transmission electron microscopy (STEM, JEOL JEM-ARM200F, and FEI Tecnai Osiris®)16 at an acceleration voltage of 200 kV was employed to characterize the microscopic composition of nanowires. The probe size was ∼0.19 nm in JEM-ARM200F and ∼0.25 nm in Tecnai Osiris™, respectively. The transport properties were measured by a microwave conductivity measurement (MCM) at RT. To estimate quantitatively the resistivity of nanowires from MCM data, the nanowire density and the nanowire length were measured from data of FESEM images. The microwave frequency and power were set at ∼9.1 GHz and 3 mW, respectively. The conductivity (Δσ) of the sample is related to the reflected...
microwave power at the resonance frequency ($\Delta\sigma = (1/A)(\Delta P/P)$), where $A$ is a sensitivity factor. The other details of the set of apparatus were described elsewhere.\textsuperscript{19,20} Previously, we have revealed the applicability of MCM for VLS grown oxide nanowires by comparing with dc contact transport measurements.\textsuperscript{21}

Figure 1(a) shows the typical scanning electron microscopy (SEM) image of Ta-doped SnO$_2$ nanowires grown onto a single crystal Al$_2$O$_3$ (110) substrate. The Ta concentration in the target was 1 at. %. SnO$_2$ nanowires were grown almost perpendicular to the substrate. The occurrence of nanowire growth was confirmed for the range of Ta concentrations in the target at least up to 5 at. %. Figure 1(b) shows the HR-TEM image of the fabricated SnO$_2$ nanowires with the selected area electron diffraction (SAED) pattern. The single crystalline nature and the [101] oriented growth of nanowires can be seen. X-ray diffraction (XRD) data also supports the [101] oriented nanowire growth, as shown in Fig. 1(c). Figure 1(d) shows the EDS measurement data, which were performed for an approximately several ten nm$^2$ area. It can be seen that Ta L shell peaks are observed, demonstrating macroscopically the presence of Ta within nanowires. Figure 2 shows the relationship between the nominal Ta concentration in the target and the incorporated macroscopic Ta concentration measured by EDS. The incorporated macroscopic Ta concentration was almost consistent with the nominal Ta concentration within the accuracy of EDS.\textsuperscript{21} Figure 2 also shows the correlation between the nominal Ta concentration and the RT resistivity of nanowires measured by MCM. The resistivity systematically decreased with the increasing nominal Ta concentration. Obviously, there is a reasonable correlation between the resistivity and the incorporated macroscopic Ta concentration. The above results consistently imply successful Ta doping into VLS grown SnO$_2$ nanowires as reported in previous works.\textsuperscript{13} However, the model based on a homogeneous dopant distribution\textsuperscript{21} estimates the dopant activation of 0.67% for the Ta (5 at. %)-doped SnO$_2$ nanowires, which is extremely low and clearly not realistic when comparing with the dopant activation (90%) for Ta-doped SnO$_2$ films.\textsuperscript{32} Therefore, we question the homogeneity of dopants incorporated into oxide nanowires in the following discussion.

Figures 3(a) and 3(b) show the STEM/EDS mapping images of Ta (1 at. %)-doped SnO$_2$ nanowires. The distribution of Ta dopants is clearly inhomogeneous, with a heavily doped shell surrounding a core of much lower Ta concentration. The presence of the heavily doped shell layer was confirmed up to Ta 5 at. %. Figure 3(c) shows the concentration line profiles of Ta and Sn along the radial direction, which were measured for Ta (5 at. %)-doped SnO$_2$ nanowires. Quantitatively, the profiles must be interpreted as data projected for a cross-sectional area. Adapting the simple core/shell structure model,\textsuperscript{23} we numerically analyzed the Ta concentration and the doping depth of the heavily doped area. The calculated doping depth and Ta concentration in the heavily doped shell are $\sim$1 nm and >40 at. %, respectively. The remaining issue is what is responsible for the electrical conduction of Ta-doped SnO$_2$ nanowires, and where. First, we exclude the presence of a conductive outer shell layer because the estimated Ta concentration of >40 at. % seems to be beyond the limit of doping regime. Second, we consider the situation that the Ta-rich most outer shell is insulative as the Ta oxides and the inner region are
conductive. The model calculation\textsuperscript{21} indicates that the inner region has $1.33 \times 10^{-7}$ Ω cm of the resistivity. This means that only 0.05 at. % of Ta concentration for the inner region is required to explain the experimental resistivity data for Ta (5 at. %)-doped SnO\textsubscript{2}.\textsuperscript{22} The conductive inner region might be created via either Ta diffusion from the nanowire surface or Ta incorporation through catalysts. The formation of insulative Ta-oxides on the nanowire surface was confirmed more clearly in Ta (20 at. %)-doped SnO\textsubscript{2} nanowires, as shown in Fig. 3(d). The crystalline Ta\textsubscript{2}O\textsubscript{5} on the nanowire surface was observed. Since Ta oxides including Ta\textsubscript{2}O\textsubscript{5} are well-known insulators, the results seem to support the scenario based on a conductive inner region.

In principle, there are two major pathways for the dopant solidification process, which are the VLS process through metal catalysts and the VS process on the nanowire surface. Although the VLS pathway is desirable for a homogeneous dopant distribution, our results highlight that the major pathway for Ta solidification is an uncatalysed VS process. Another experimental evidence to support the VS pathway can be given by thin film VS experiments in the absence of metal catalysts. The VS experiments were performed under the same conditions as the VLS experiments. The Ta concentration of fabricated thin films (in the case of Ta 5 at. % nominal concentration) was over 95%, i.e., Ta-rich phases are easily formed via the VS growth process. Thus, all our experimental results consistently support the uncatalysed VS pathway for Ta solidification process. Next, we discuss what essentially determines the major pathway of dopants in VLS grown oxide nanowires. Within the classical framework of VLS, supplied atoms must be selectively incorporated into metal catalysts. Therefore, it is essential to prevent an uncatalysed VS surface growth to realize a well-defined VLS growth. This criterion must be applicable even for impurity dopants. In the case of Ta doping, the vapor pressure of Ta is rather low compared with that of Sn;\textsuperscript{24} for example, the vapor pressure of Ta is $10^{-4}$ mbar, respectively.\textsuperscript{24} Thus, the VS surface growth of Ta must be given by thin film VS experiments in the absence of metal catalysts. An-dopant distribution, our results highlight that the major pathway for Ta solidification is an uncatalysed VS process. An-

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